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Dimensions

Footprint	3813
L	3.81mm +/-0.38mm
W	1.27mm +/-0.38mm
H	1.27mm +/-0.38mm
S	0.76mm +0.25/-0.13mm
F	1.27mm +/-0.13mm
K	0.76mm MIN
P	0.38mm MIN

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	2500

General Information

Series	T409 CWR09
Dielectric	MnO2 Tantalum
Style	SMD Chip
Description	SMD, MnO2, Molded, Military Equivalent
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
SCIP Number	573c56ea-c4cc-4850-b749-53802fe9068f
Termination	Hot Solder Dipped
Qualifications	MIL-PRF-55365/4, CWR09 Style
AEC-Q200	No
Component Weight	68.73 mg
Notes	Note: When Option C Is Selected For Lead Material, Add An Additional 0.38mm To The Tolerances For "L", "W", "H", "K", "F" And "S".
MSL	1

Specifications

Capacitance	1 uF
Capacitance Tolerance	5%
Voltage DC	20 VDC (85C), 13.4 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	P (0.1%/1000 Hrs)
Resistance	12 Ohms (100kHz 25C)
Ripple Current	76 mA (rms, 100kHz 25C)
Leakage Current	1 uA (5min 25°C)
Testing and Reliability	Surge Testing At -55C And +85C Before Weibull

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